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30. (Amended) An integrated circuit structure comprising:

a substrate;

an opening in said substrate, said opening consisting of a first rectangular portion and a second rectangular portion, wherein said second rectangular portion has larger dimensions than said first rectangular portion; and

a conductor filling said opening.

35. (Amended) An integrated circuit structure comprising:

a substrate;

an opening in said substrate, said opening consisting of a first rectangular portion, a second rectangular portion, and a third rectangular portion, wherein said second rectangular portion has larger dimensions than said first rectangular portion and said third rectangular portion; and

a conductor filling said opening.

Please add the following new claims:

39. The integrated circuit in claim 35, wherein said first rectangular portion and said third rectangular portion have different dimensions.

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- 40. An integrated circuit structure comprising:
 - a substrate;
- a bottle-shaped opening in said substrate, said bottle-shaped opening comprising a first rectangular portion and a second rectangular portion, wherein said second rectangular portion has larger dimensions than said first rectangular portion; and
 - a conductor filling said opening.
- 41. The integrated circuit in claim 40, wherein said second rectangular portion is deeper in said opening than said first rectangular portion.
- 42. The integrated circuit in claim 40, wherein said first rectangular portion is deeper in said opening than said second rectangular portion.
- **43**. The integrated circuit in claim 40, wherein said lateral openings increase a surface area of said trench capacitor.
- The integrated circuit in claim 40, wherein said lateral openings increase a capacitance of 44. said structure.